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FEE TRANSMITTAL for FY 2005

Effective 10/01/2004. Patent fees are subject to annual revision.

☐ Applicant claims small entity status. See 37 CFR 1.27

TOTAL AMOUNT OF PAYMENT (\$) 110.00

Complete if Known	
Application Number	10/659,596
Filing Date	9/9/2003
First Named Inventor	F. Gonzalez
Examiner Name	T.P. le
Art Unit	2818
Attorney Docket No.	MI22-2393

METHOD OF PAYMENT (check all that apply)

☒ Check ☐ Credit card ☐ Money Order ☐ Other ☐ None

☒ Deposit Account:

Deposit Account Number: 23-0925

Deposit Account Name: Wells St. John P.S.

The Director is authorized to: (check all that apply)

☐ Charge fee(s) indicated below ☒ Credit any overpayments

☒ Charge any additional fee(s) or any underpayment of fee(s)

☐ Charge fee(s) indicated below, except for the filing fee to the above-identified deposit account.

1. BASIC FILING FEE					Fee Description	Fee Paid
Large Entity Fee Code (\$)	Small Entity Fee Code (\$)	Fee	Fee			
1001	2001	790	395		Utility filing fee	
1002	2002	350	175		Design filing fee	
1003	2003	550	275		Plant filing fee	
1004	2004	790	395		Reissue filing fee	
1005	2005	160	80		Provisional filing fee	
SUBTOTAL (1)					(\$)	

2. EXTRA CLAIM FEES FOR UTILITY AND REISSUE

Total Claims: -20** = X =

Independent Claims: -3** = X =

Multiple Dependent: =

Large Entity Fee Code (\$)	Small Entity Fee Code (\$)	Fee	Fee	Fee Description		
1202	2202	18	9	Claims in excess of 20		
1201	2201	88	44	Independent claims in excess of 3		
1203	2203	300	150	Multiple dependent claim, if not paid		
1204	2204	88	44	** Reissue independent claims over original patent		
1205	2205	18	9	** Reissue claims in excess of 20 and over original patent		
SUBTOTAL (2)					(\$)	

**or number previously paid, if greater; For Reissues, see above

3. ADDITIONAL FEES					Fee Description	Fee Paid
Large Entity Fee Code (\$)	Small Entity Fee Code (\$)	Fee	Fee			
1051	2051	130	65		Surcharge - late filing fee or oath	
1052	2052	50	25		Surcharge - late provisional filing fee or cover sheet	
1053	1053	130	130		Non-English specification	
1812	1812	2,520	2,520		For filing a request for <i>ex parte</i> reexamination	
1804	1804	920*	920*		Requesting publication of SIR prior to Examiner action	
1805	1805	1,840*	1,840*		Requesting publication of SIR after Examiner action	
1251	2251	110	55		Extension for reply within first month	
1252	2252	430	215		Extension for reply within second month	
1253	2253	980	490		Extension for reply within third month	
1254	2254	1,530	765		Extension for reply within fourth month	
1255	2255	2,080	1,040		Extension for reply within fifth month	
1401	2401	340	170		Notice of Appeal	
1402	2402	340	170		Filing a brief in support of an appeal	
1403	2403	300	150		Request for oral hearing	
1451	2451	1,510	1,510		Petition to institute a public use proceeding	
1452	2452	110	55		Petition to revive - unavoidable	
1453	2453	1,370	685		Petition to revive - unintentional	
1501	2501	1,370	685		Utility issue fee (or reissue)	
1502	2502	490	245		Design issue fee	
1503	2503	660	330		Plant issue fee	
1460	2460	130	130		Petitions to the Commissioner	
1807	2807	50	50		Processing fee under 37 CFR 1.17(q)	
1806	2806	180	180		Submission of Information Disclosure Stmt	
8021	28021	40	40		Recording each patent assignment per property (times number of properties)	
1809	2809	790	395		Filing a submission after final rejection (37 CFR 1.129(a))	
1810	2810	790	395		For each additional invention to be examined (37 CFR 1.129(b))	
1801	2801	790	395		Request for Continued Examination (RCE)	
1802	2802	900	900		Request for expedited examination of a design application	
Other fee (specify)						
*Reduced by Basic Filing Fee Paid						
SUBTOTAL (3)					(\$) 110.00	

SUBMITTED BY		(Complete if applicable)	
Name (Print/Type)	David G. Latwesen, Ph.D.	Registration No. (Attorney/Agent)	38,533
Signature		Telephone	509-624-4276
		Date	November 7, 2004

WARNING: Information on this form may become public. Credit card information should not be included on this form. Provide credit card information and authorization on PTO-2038.

This collection of information is required by 37 CFR 1.17 and 1.27. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 12 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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EV372467008



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 10/659,596
Confirmation No. 5277
Filing Date September 9, 2003
Inventor F. Gonzalez
Assignee Micron Technology, Inc.
Group Art Unit 2818
Examiner T. P. Le
Attorney's Docket No. MI22-2393
Customer No. 021567
Title: Methods Of Forming Semiconductor Constructions

EV372467008

TERMINAL DISCLAIMER

I, David G. Latwesen, Ph.D., residing at Spokane, Washington, represent that I am the attorney of record for Micron Technology, Inc., a corporation of the state of Delaware. Micron Technology, Inc. is the owner of all right, title and interest of this U.S. Patent Application Serial No. 10/659,596, filed September 9, 2003, as evidenced by an assignment recorded June 12, 2000, at Reel 010868, Frames 0158 in the U.S. Patent and Trademark Office.

Micron Technology, Inc. is also the owner of all right, title and interest in U.S. Patent No. 6,635,552 as evidenced by an assignment recorded June 12, 2000, at Reel 010868, Frames 0158, in the U.S. Patent and Trademark Office.

The evidentiary documents have been reviewed, and I certify that, to the best of assignee's knowledge and belief, title is in the assignee seeking to take this action.

Micron Technology, Inc. hereby disclaims the terminal part of any future patent granted on this U.S. Patent Application Serial No. 10/659,596 which

extends beyond the expiration date of U.S. Patent No. 6,635,552, and further hereby agrees that any future patent so granted on this U.S. Patent Application Serial No. 10/659,596* shall be enforceable only for and during such period that the legal title on the U.S. Patent No. 6,635,552 shall be the same as the legal title to any patent issued from U.S. Patent Application Serial No. 10/659,596. This agreement is to run with any patent granted on the 10/659,596 application and is to be binding upon the grantee of such patent and its successors or assigns.

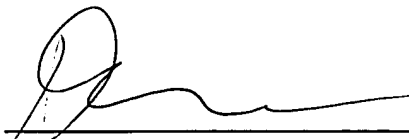
Micron Technology, Inc. does not disclaim any terminal part of any patent granted on this 10/659,596 application prior to the expiration date of the full statutory term of the United States Patent No. 6,635,552 in the event that it later: expires for failure to pay a maintenance fee, is held unenforceable, is found invalid by a court of competent jurisdiction, is statutorily disclaimed in whole or terminally disclaimed under 37 C.F.R. §1.321(a), has all claims canceled by a reexamination certificate, is reissued in any manner or is otherwise terminated prior to expiration of its full statutory term as presently shortened by any terminal disclaimer, except for the separation of legal title stated above.

The fee required by 37 C.F.R. 1.20(d) is submitted herewith. The Commissioner is hereby authorized to charge payment of any additional fees or credit overpayments to Deposit Account No. 23-0925.

The undersigned, David G. Latwesen, Ph.D., hereby indicates that he is authorized to sign this document on behalf of the assignee, Micron Technology, Inc.

Respectfully submitted,

Dated: November 2, 2004

By: 

David G. Latwesen, Ph.D.
Reg. No. 38,533